

Germany-Ingolstadt: Microelectronic machinery and apparatus

OJ S 176/2019 12/09/2019

Contract notice

Supplies

Legal Basis:

Directive 2014/24/EU

Section I: Contracting authority

I.1. Name and addresses

Official name: Technische Hochschule Ingolstadt

Postal address: Esplanade 10

Town: Ingolstadt

NUTS code: DE211 Ingolstadt, Kreisfreie Stadt

Postal code: 85049

Country: Germany

Contact person: Bhogaraju, Sri Krishna

E-mail: info@thi.de

Telephone: +49 84193480

Fax: +49 8419348200

Internet address(es):

Main address: <https://www.auftraege.bayern.de>

Address of the buyer profile: <https://www.thi.de>

I.2. Information about joint procurement

The contract is awarded by a central purchasing body

I.3. Communication

The procurement documents are available for unrestricted and full direct access, free of charge, at: <https://www.eprocurement.bayern.de/evergabe.bieter//DownloadTenderFiles.ashx?subProjectId=GjEvW70r%252baw%253d>

Additional information can be obtained from the abovementioned address

Tenders or requests to participate must be submitted electronically via: <https://www.auftraege.bayern.de>

I.4. Type of the contracting authority

Other type: Technische Hochschule

I.5. Main activity

Education

Section II: Object

II.1. Scope of the procurement

II.1.1. Title

Bonder – Microelectronics packaging

Reference number: 2019000384

II.1.2.

Main CPV code

31712100 Microelectronic machinery and apparatus

II.1.3. Type of contract

Supplies

II.1.4. Short description

As part of the IQLED project, Technische Hochschule Ingolstadt (THI) would like to procure an advanced bonder for the research lab „Microelectronics packaging“.

Im Rahmen des IQLED-Projekts möchte die Technische Hochschule Ingolstadt (THI) einen Advanced Bonder für das Forschungslabor 'Microelectronics Packaging' beschaffen.

II.1.5. Estimated total value**II.1.6. Information about lots**

This contract is divided into lots: no

II.2. Description**II.2.3. Place of performance**

NUTS code: DE211 Ingolstadt, Kreisfreie Stadt

II.2.4. Description of the procurement

As part of the IQLED project, Technische Hochschule Ingolstadt (THI), would like to procure an advanced bonder for reasearch lab „Microelectronics packaging“.

Im Rahmen des IQLED Projektes möchte die THI einen Advanced Bonder für das Forschungslabor „Microelectronics Packaging“ beschaffen.

II.2.5. Award criteria

Criteria below

Quality criterion - Name: Leistungskriteriea / Weighting: 50

Price - Weighting: 50

II.2.6. Estimated value**II.2.7. Duration of the contract, framework agreement or dynamic purchasing system**

Start: 01/11/2019 End: 20/12/2019

This contract is subject to renewal: yes

Description of renewals:

Je nach tatsächliem Lieferdatum

II.2.10. Information about variants

Variants will be accepted: yes

II.2.11. Information about options

Options: no

II.2.13. Information about European Union funds

The procurement is related to a project and/or programme financed by European Union funds:
no

II.2.14. Additional information**Section III: Legal, economic, financial and technical information**

III.1. Conditions for participation

III.1.1. Suitability to pursue the professional activity, including requirements relating to enrolment on professional or trade registers

List and brief description of conditions:

Handelsregistereintragung

III.1.2. Economic and financial standing

Selection criteria as stated in the procurement documents

III.1.3. Technical and professional ability

Selection criteria as stated in the procurement documents

Section IV: Procedure

IV.1. Description

IV.1.1. Type of procedure

Open procedure

IV.1.3. Information about a framework agreement or a dynamic purchasing system

IV.1.8. Information about the Government Procurement Agreement (GPA)

The procurement is covered by the Government Procurement Agreement: yes

IV.2. Administrative information

IV.2.2. Time limit for receipt of tenders or requests to participate

Date: 11/10/2019 Local time: 23:59

IV.2.3. Estimated date of dispatch of invitations to tender or to participate to selected candidates

IV.2.4. Languages in which tenders or requests to participate may be submitted

German

IV.2.6. Minimum time frame during which the tenderer must maintain the tender

Tender must be valid until: 11/11/2019

IV.2.7. Conditions for opening of tenders

Date: 11/10/2019 Local time: 23:59

Section VI: Complementary information

VI.1. Information about recurrence

This is a recurrent procurement: no

VI.3. Additional information

VI.4. Procedures for review

VI.4.1. Review body

Official name: Regierung von Oberbayern – Vergabekammer Südbayern

Postal address: Maximilianstr. 39

Town: München

Postal code: 80538

Country: Germany

E-mail: vergabekammer.suedbayern@reg-ob.bayern.de

Telephone: +49 8921762411

Fax: +49 8921762847

VI.5. Date of dispatch of this notice

10/09/2019